

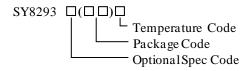
High Efficiency, 800kHz, 40V Input, 3A Non-synchronous Step Down Regulator

General Description

The SY8293 is a high efficiency 800 kHz, adaptive constant OFF time controlled non-synchronous stepdown DC-DC regulator capable of delivering 3A output current respectively. The SY8293 can operate over a wide input voltage range from 5V to 40V and integrate the main switch with very low R_{DS(ON)} to minimize the conduction loss.

Low output voltage ripple and small external inductor and capacitor sizes are achieved with 800 kHz switching frequency.

Ordering Information



Ordering Number	Package type	Note
SY8293FCC	SO8E	

Features

- 5-40V Input Voltage Range
- Low R_{DS(ON)} for Internal N-Channel Power FET: $180 \text{ m}\Omega$
- 800kHz Switching Frequency
- Adaptive Constant OFF Time Control
- Internal Soft-start Limits the Inrush Current
- 2% 0.6V Reference
- RoHS Compliant and Halogen Free
- Compact Package: SO8E

Applications

- Set Top Box
- Portable TV
- Access Point Router
- DSL Modem
- LCD TV

Typical Applications

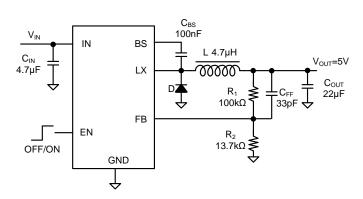


Figure 1. Schematic Diagram

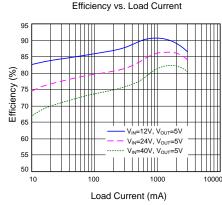
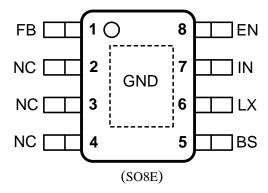


Figure 2. Efficiency Figure



Pinout (top view)



Top Mark: ARZxyz (Device code: ARZ, x=year code, y=week code, z= lot number code)

Pin Name	Pin Number	Pin Description	
FB	1	Output feedback pin. Connect this pin to the center point of the output resistor divider (as shown in Figure 1) to program the output voltage: $V_{OUT}=0.6\times(1+R_1/R_2)$	
GND Exposed paddle Ground pin		Ground pin	
BS	5	Boot-strap pin. Supply high side gate driver. Decouple this pin to the LX pin with a 0.1µF ceramic capacitor.	
LX	6	Inductor pin. Connect this pin to the switching node of inductor	
IN	7	7 Input pin. Decouple this pin to GND pin with at least a 4.7μF ceramic capacit	
EN 8 Enable control. Pull high to turn on. Do not leave it floating.		Enable control. Pull high to turn on. Do not leave it floating.	
NC	2, 3, 4	Not connected.	

Absolute Maximum Ratings (Note 1)

8 , ,	
Supply Input Voltage	
Enable Voltage	$V_{IN} + 0.6V$
FB Voltage	3.6V
BS to LX Voltage	3.6V
Power Dissipation, PD @ TA = 25°C, SO8E	3.3W
Package Thermal Resistance (Note 2)	
θ JA	30°C/W
θ JC	
Junction Temperature Range	150°C
Lead Temperature (Soldering, 10 sec.)	
Storage Temperature Range	
Recommended Operating Conditions (Note 3)	
Supply Input Voltage	5V to 40V
BS to LX Voltage	3.3V
Junction Temperature Range	



Electrical Characteristics

 $(V_{IN} = 12V, V_{OUT} = 5V, L = 3.9 \mu H, C_{OUT} = 22 \mu F, T_{A} = 25 ^{\circ}C, I_{OUT} = 1A unless otherwise specified.)$

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Input Voltage Range	$V_{\rm IN}$		5		40	V
Input UVLO Threshold	V_{UVLO}	Rising		4.5		V
Input UVLO Threshold	V UVLO	Falling		4.3		V
Input UVLO Hysteresis	$V_{\rm UVLO_HYS}$			200		mV
Quiescent Current	I_Q	$I_{OUT}=0$, $V_{FB}=V_{REF}\times 105\%$		160		μA
Shutdown Current	I_{SHDN}	EN=0			10	μA
Feedback Reference Voltage	V_{REF}		0.588	0.6	0.612	V
FB Input Current	I_{FB}	$V_{ m FB} = V_{ m IN}$	-50		50	nA
Power FET RON	R _{DS(ON)1}			180		m Ω
Power FET Current Limit	I_{LIM}		3.4			Α
EN Rising Threshold	V_{ENH}		1.5			V
EN Falling Threshold	V_{ENL}				0.4	V
Minimum OFF Time	t _{OFF}				100	ns
Minimum ON Time	t _{OFF}				100	ns
Maximum ON Time	ton			2		us
Oscillator Frequency	fosc			800		kHz
Thermal Shutdown	T_{SD}			150		°C
Temperature	1 SD			130		
Thermal Shutdown Recovery Hysteresis	T _{HYS}			15		°C

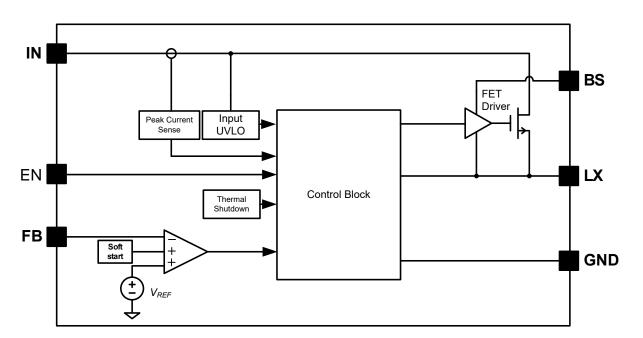
Note 1: Stresses beyond the "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only. Functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Note 2: θ_{JA} is measured in the natural convection at $T_A = 25^{\circ}C$ on a low effective single layer thermal conductivity test board of JEDEC 51-3 thermal measurement standard.

Note 3: The device is not guaranteed to function outside its operating conditions.

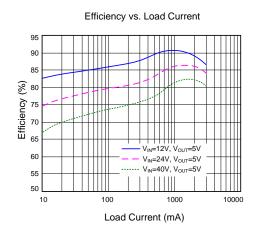


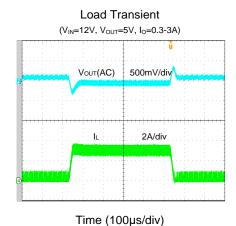
Block Diagram



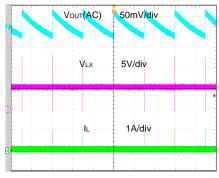


Typical Performance Characteristics

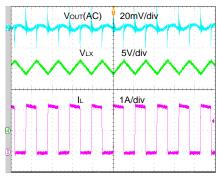








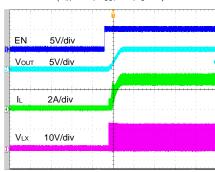
Output Ripple (V_{IN}=12V, V_{OUT}=5V, I_O=3A)



Time (10ms/div)

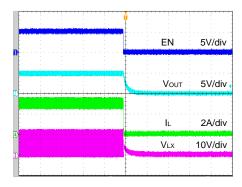
Time (1µs/div)





Time (800µs/div)

EN Shutdown (V_{IN}=12V, V_{OUT}=5V, I_O=3A)

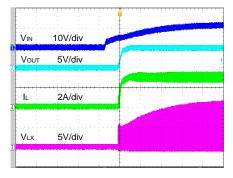


Time (200µs/div)



VIN Startup

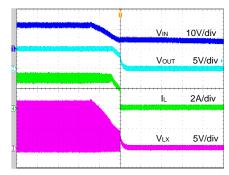
 $(V_{IN}=12V, V_{OUT}=5V, I_{O}=3A)$



Time (2ms/div)

VIN Shutdown

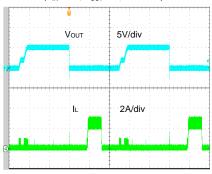
(V_{IN} =12V, V_{OUT} =5V, I_{O} =3A)



Time (400µs/div)

Short Circuit Protection

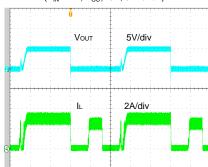
(V_{IN}=12V, V_{OUT}=5V, 0A~short)



Time (2ms/div)

Short Circuit Protection

(V_{IN}=12V, V_{OUT}=5V, 3A~short)



Time (2ms/div)





Operation

SY8293 is an asynchronous Buck regulator that integrates the PWM control, main switch on the same die. With ultra low $R_{\rm DS(ON)}$ power switch and proprietary PWM control, this regulator can achieve high efficiency and fast transient response. High switch frequency minimizes the external inductor and capacitor size, thus minimize the PCB area and cost. SY8293 also features cycle-by-cycle current limit, output short circuit protection and thermal shutdown protection.

Applications Information

Because of the high integration in the SY8293, the application circuit based on this regulator IC is rather simple. Only the input capacitor $C_{\rm IN}$, the output capacitor $C_{\rm OUT}$, the output inductor L, the rectifier diode D and the feedback resistors (R_1 and R_2) need to be selected for the targeted applications.

Feedback Resistor Dividers R1 and R2:

Choose R_1 and R_2 to program the proper output voltage. To minimize the power consumption under light loads, it is desirable to choose large resistance values for both R_1 and R_2 . A value of between $10k\Omega$ and $1M\Omega$ is highly recommended for both resistors. If V_{OUT} is 5V, R_1 =100k is chosen, then using following equation, R_2 can be calculated to be 13.7k:

$$R_2 = \frac{0.6V}{V_{OUT} - 0.6V} R_1.$$

$$0.6V_{FB}$$

$$R_1$$

$$R_2$$

Input Capacitor Cin:

The ripple current through input capacitor is calculated as:

$$I_{\text{CIN_RMS}} \! = \! I_{\text{OUT}} \! \times \! \sqrt{D(1 \text{-}D)} \; . \label{eq:cont_RMS}$$

To minimize the potential noise problem, place a typical X5R or better grade ceramic capacitor really close to the IN pin and the negative end of rectifier. A low ESR ceramic capacitor is recommended with greater than $4.7\mu F$ capacitance.

Output Capacitor Cout:

The output capacitor is selected to handle the output ripple noise requirements. Both steady state ripple and transient requirements must be taken into consideration when selecting this capacitor. For the best performance, it is recommended to use an X5R or better grade ceramic capacitor with greater than 22µF capacitance.

Output Inductor L:

There are several considerations in choosing this inductor.

1) Choose the inductance to provide the desired ripple current. It is suggested to choose the ripple current to be about 40% of the maximum output current. The inductance is calculated as:

$$L = \frac{V_{\text{OUT}}(1 - V_{\text{OUT}}/V_{\text{IN,MAX}})}{f_{\text{SW}} \times I_{\text{OUT,MAX}} \times 40\%}$$

Where f_{SW} is the switching frequency and $I_{OUT,MAX}$ is the maximum load current.

The SY8293 is quite tolerant of different ripple current amplitude. Consequently, the final choice of inductance can be slightly off the calculation value without significantly impacting the performance.

 The saturation current rating of the inductor must be selected to be greater than the peak inductor current under full load conditions.

$$I_{SAT, \, MIN} > I_{OUT, \, MAX} + \frac{V_{OUT}(1\text{-}V_{OUT}/V_{IN, MAX})}{2 \times f_{SW} \times L}$$

3) The DCR of the inductor and the core loss at the switching frequency must be low enough to achieve the desired efficiency requirement. It is desirable to choose an inductor with DCR<50mΩ to achieve a good overall efficiency.

External Bootstrap Cap

This capacitor provides the gate driver voltage for internal high side MOSFET. A 100nF low ESR ceramic capacitor connected between the BS pin and the LX pin is recommended.





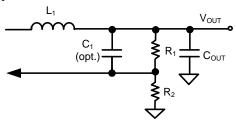


Rectifier Diode

Because of high switching speed of SY8293, a schottky diode with low forward voltage and fast switching speed is desirable for the application. The voltage rating of the diode must be higher than maximum output voltage. The diode's average and peak current rating should exceed the average output current and peak current.

Load Transient Considerations:

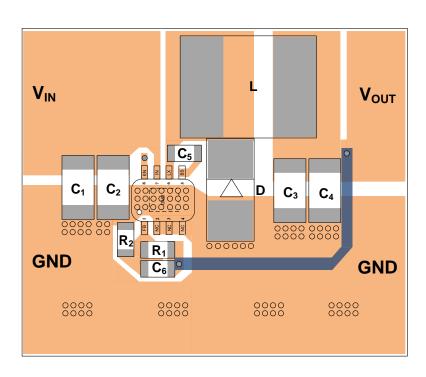
The SY8293 integrates the compensation components to achieve good stability and fast transient responses. In some applications, adding a small ceramic cap in parallel with R1 may further speed up the load transient response and is it is recommended for high step load applications.



Layout Design:

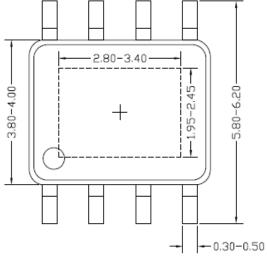
The layout design of SY8293 regulator is relatively simple. For the best efficiency and minimum noise problem, we should place the following components close to the IC: C_{IN} , L, R_1 and R_2 .

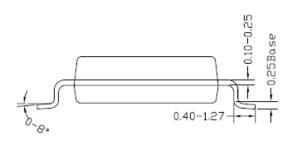
- 1) It is desirable to maximize the PCB copper area connecting to GND pin to achieve the best thermal and noise performance. If the board space allowed, a ground plane is highly desirable.
- 2) The loop area formed by IN, LX, CIN and the rectifier must be minimized.
- 3) The PCB copper area associated with LX pin must be minimized to avoid the potential noise problem.
- 4) The components R₁ and R₂, and the trace connecting to the FB pin must NOT be adjacent to the LX net on the PCB layout to avoid the noise problem.
- 5) If the system chip interfacing with the EN pin has a high impedance state at shutdown mode and the IN pin is connected directly to a power source, it is desirable to add a pull down $1M\Omega$ resistor between the EN and GND pins to prevent the noise from falsely turning on the regulator at shutdown mode.



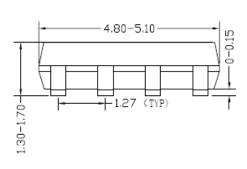


SO8E Package Outline & PCB layout

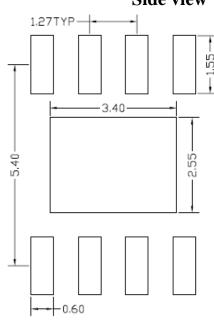




Top view



Side view



Front view

Recommended PCB layout (Reference Only)

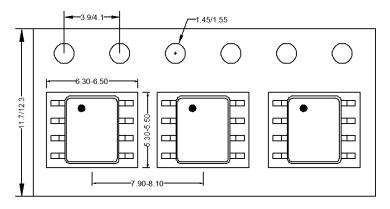
All dimension in millimeter and exclude mold flash & metal burr. **Notes:**



Taping & Reel Specification

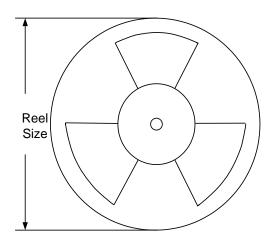
1. Taping orientation

SO8E



Feeding direction

2. Carrier Tape & Reel specification for packages



Package types	Tape width	Pocket	Pocket Reel size		Leader *	Qty per reel
r ackage types	(mm)	pitch(mm)	(Inch)	length(mm)	length (mm)	(pcs)
SO8E	12	8	13"	400	400	2500

Others: NA



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